



SURFACE MOUNT

# RF Transformer

## TC1-42+

Mini-Circuits

50Ω 0.25 to 400 MHz

### FEATURES

- Plastic base with solder plated leads
- Excellent amplitude unbalance, 0.2 dB typ. and phase unbalance, 3 deg. typ. in 1dB bandwidth
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-1A

**+RoHS Compliant**

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

### APPLICATIONS

- Balanced to unbalanced
- Push-pull amplifier

### ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		Ohm
Frequency Range		0.25		400	MHz
Insertion Loss*	0.25-400		3		dB
	0.35-250		2		
	0.7-150		1		

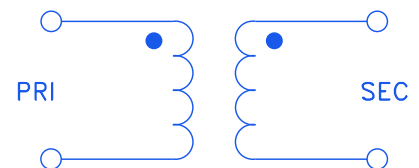
\*Insertion Loss is referenced to mid-band loss, 0.3 dB typ.

### MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

### CONFIG. C



REV. C  
ECO-022029  
TC1-42+  
MCL NY  
240607

Mini-Circuits

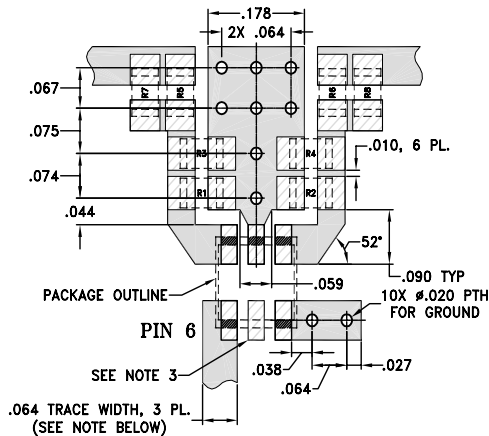


### PIN CONNECTIONS

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2.5

PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-77  
SUGGESTED PCB LAYOUT (PL-243)

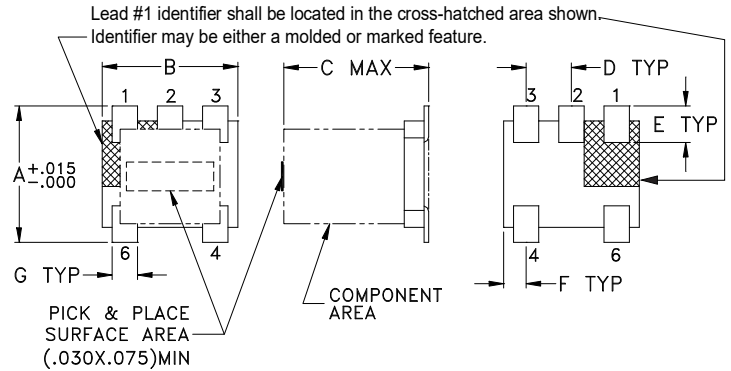


RESISTORS R1-R8: 0805 SIZE

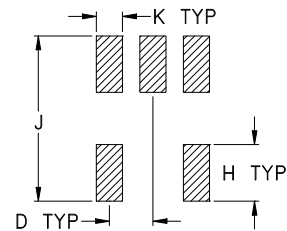
- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.  
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.  
3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLES.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

### OUTLINE DRAWING



### PCB Land Pattern



Suggested Layout,  
Tolerance to be within ±.002

### OUTLINE DIMENSIONS (Inch/mm)

A	B	C	D	E	F
.150	.150	.160	.050	.040	.025
3.81	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

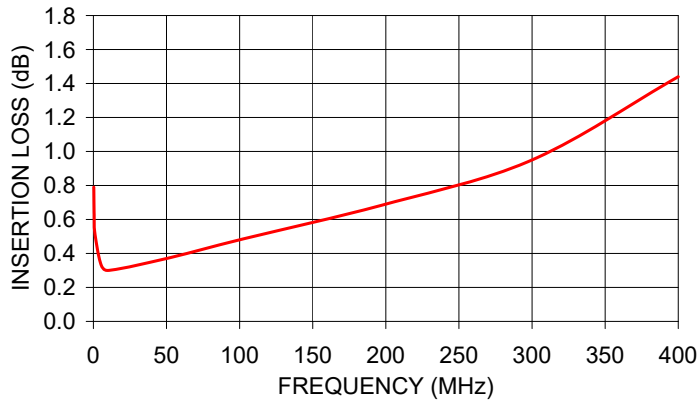
### TAPE & REEL INFORMATION: F17



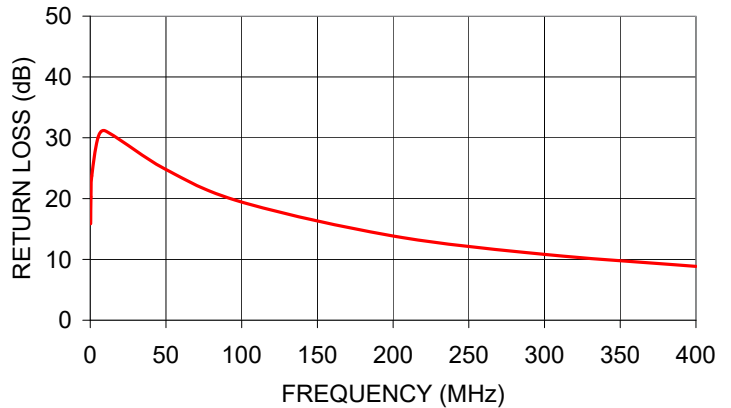
### TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.25	0.79	15.85
0.50	0.63	20.29
1.00	0.52	23.72
5.00	0.34	29.93
10.00	0.30	31.13
50.00	0.37	24.78
100.00	0.48	19.43
200.00	0.69	13.85
300.00	0.95	10.83
400.00	1.44	8.85

INSERTION LOSS



RETURN LOSS



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
  - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
  - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/terms/viewterm.html](http://www.minicircuits.com/terms/viewterm.html)


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# TC1-42+

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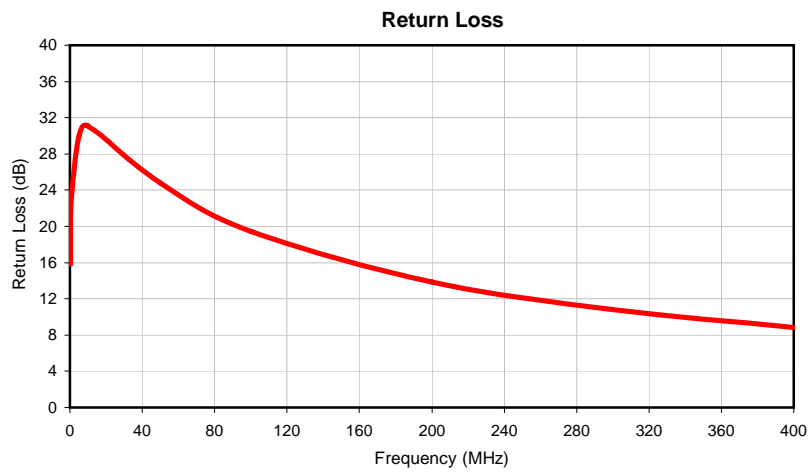
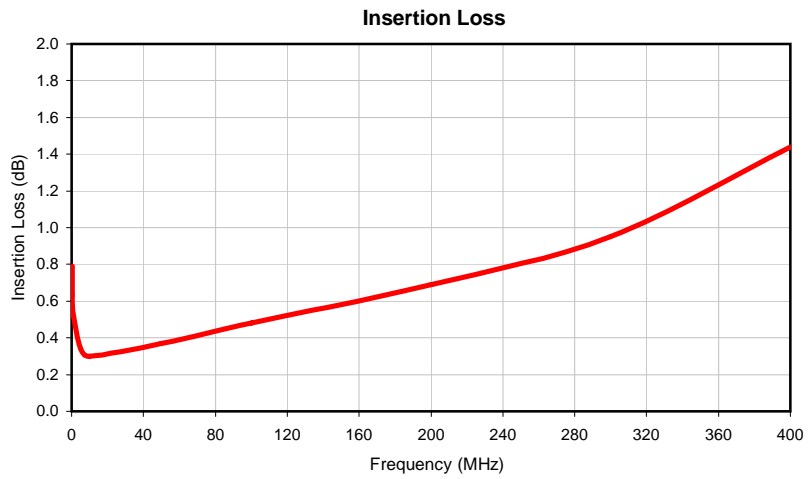


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 The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: [www.minicircuits.com](http://www.minicircuits.com)

IF/RF MICROWAVE COMPONENTS

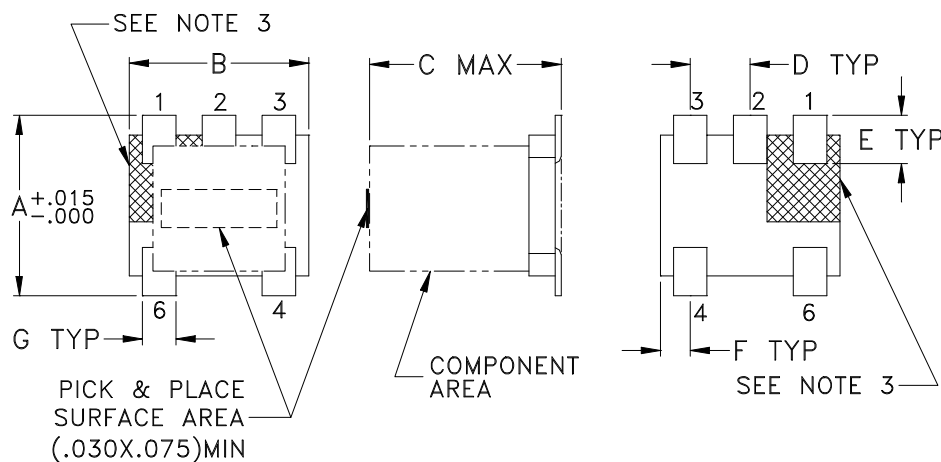
REV. X1  
TC1-42+  
12/21/2007  
Page 1 of 1

## Typical Performance Data

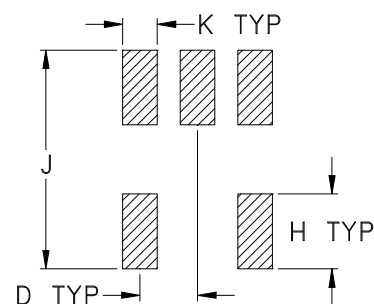


## Outline Dimensions

AT224-1A



## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

### Notes:

- Case material: Plastic.
- Termination finish:  
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.  
Identifier may be either a molded or marked feature.



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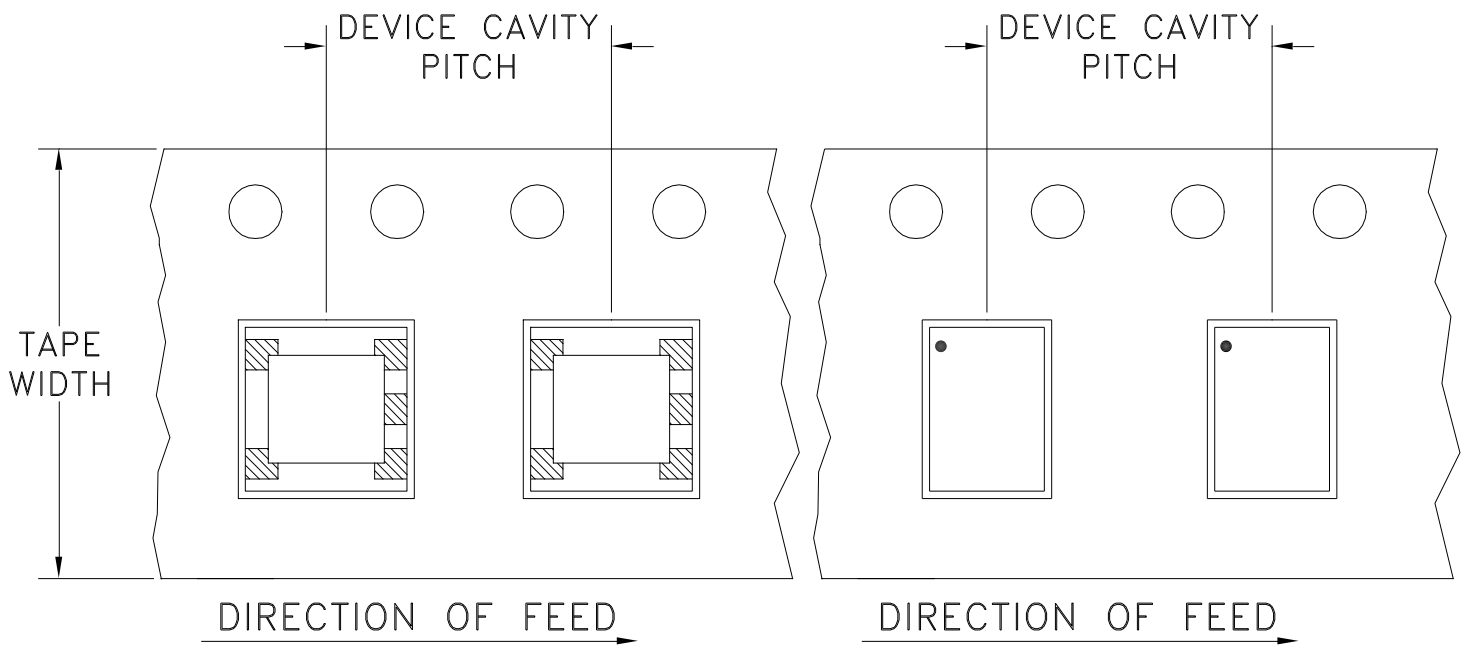


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RF/MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F17

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
			2000	

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



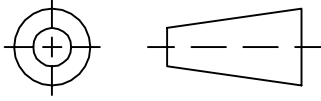
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RF/IF MICROWAVE COMPONENTS

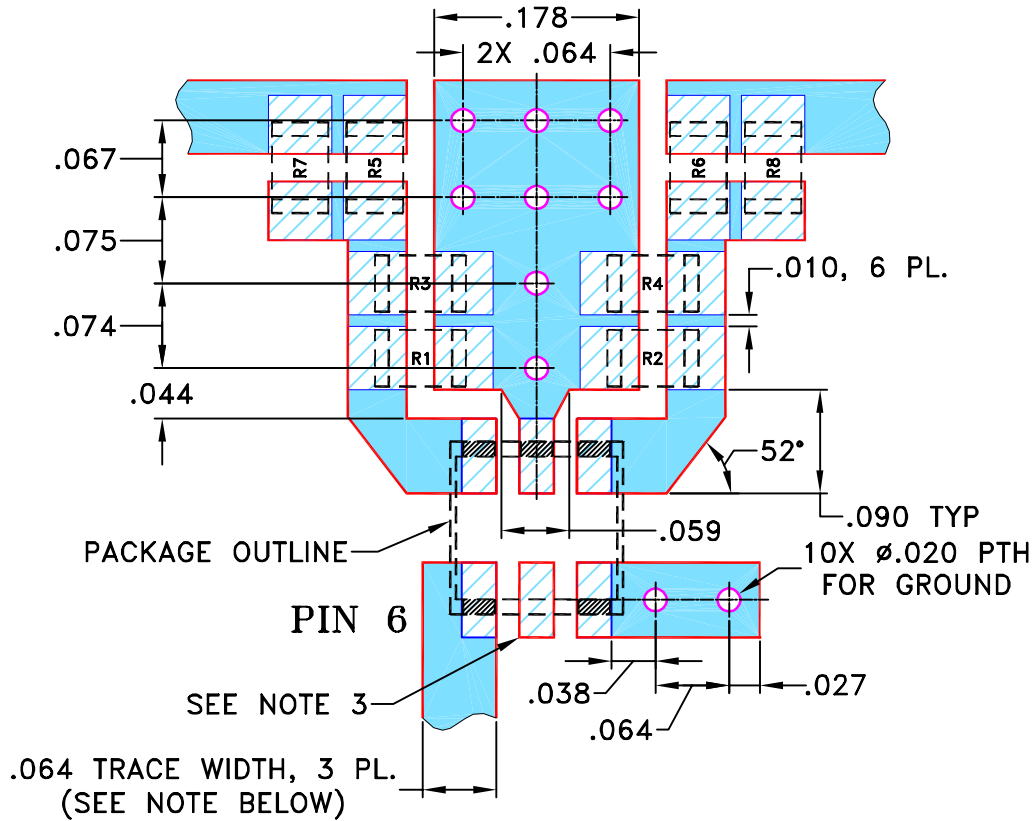
THIRD ANGLE PROJECTION



REVISIONS

REV OR	ECN No.	DESCRIPTION	DATE	DR	AUTH
	M106588	NEW RELEASE	08/28/06	AV	IG

SUGGESTED MOUNTING CONFIGURATION FOR AT224/DB714 CASE STYLES, "gs/ha/hd" PIN CONNECTIONS



RESISTORS R1-R8: 0805 SIZE

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DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DRAWN	AV	07/31/06
CHECKED	IL	08/28/06
APPROVED	IG	08/28/06



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Brooklyn NY 11235

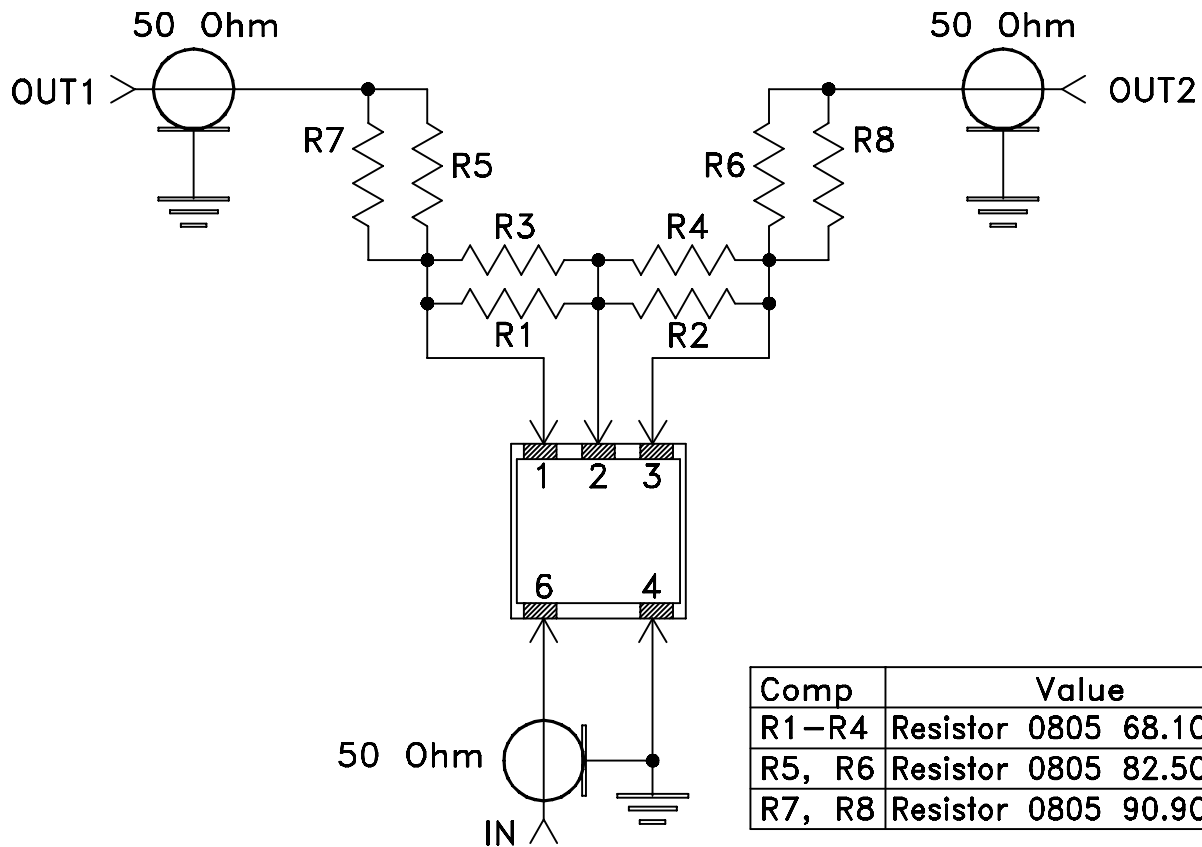
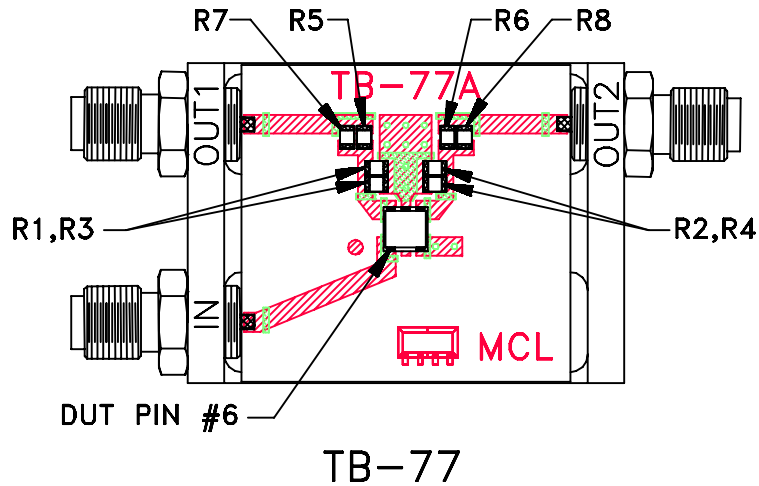
PL, gs/ha/hd, AT224/DB714, TC/TCM

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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-243	OR
FILE:	98PL243	SCALE:	SHEET:
		6:1	1 OF 1



# Evaluation Board and Circuit



Schematic Diagram

1. 50 Ohm SMA Female Connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215